



DOCKET NO.: TALW-0180

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Inoue, et al.

Confirmation No.: 3801

Serial No.: 09/805,841

Group Art Unit: 1741

Filing Date: March 14, 2001

Examiner: Wesley A. Nicolas

For: Electrolytic Plating Method and Device for a Wiring Board

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DATE OF DEPOSIT: March 5, 2003

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Assistant Commissioner for Patents  
Washington DC 20231

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REPLY PURSUANT TO 37 CFR § 1.111

In reply to the Office Action mailed November 5, 2002, Applicants respectfully request that the Examiner amend the above-identified application as follows and reconsider the application in view of the amendment and the following remarks. No new matter has been added by the amendment.

Attached hereto is a marked-up version of the changes made to the application by the current amendment. The attached pages are captioned "Version with markings to show changes made."